

SURFACE MOUNT SILICON SCHOTTKY DIODES



The following configurations are available: **CMSD6263:** SINGLE

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DUAL, COMMON ANODE	Ν
DUAL, COMMON CATHODE	ſ
DUAL, IN-SERIES	ľ
	DUAL, COMMON ANODE DUAL, COMMON CATHODE DUAL, IN-SERIES

Central Semiconductor Corp.

www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMSD6263 series devices are high voltage silicon Schottky diodes, epoxy molded in a SOT-323 surface mount package, designed for low current fast switching applications requiring a low forward voltage drop.

MARKING CODE: 76D MARKING CODE: 98D MARKING CODE: 97D MARKING CODE: 96D

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V _{RRM}	70	V
Continuous Forward Current	١ _F	15	mA
Peak Forward Surge Current, tp=1.0s	IFSM	50	mA
Power Dissipation	PD	275	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	455	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (TA=25°C unless otherwise noted)

				,	
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _R	V _R =50V		10	200	nA
BVR	I _R =10µA	70			V
VF	I _F =1.0mA		395	410	mV
CJ	V _R =0, f=1.0MHz			2.0	pF
t _{rr}	I _R =I _F =10mA, I _{rr} =1.0mA, R _L =100Ω			5.0	ns

R4 (11-December 2015)

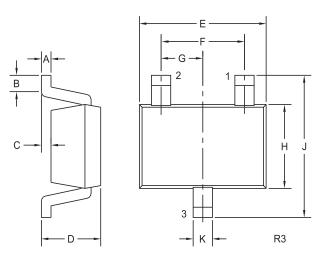




SURFACE MOUNT SILICON SCHOTTKY DIODES

CMSD6263 CMSD6263A

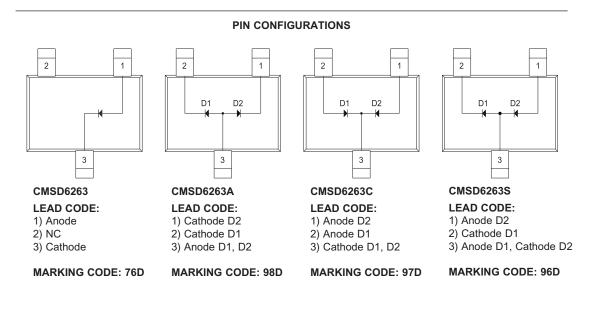
CMSD6263C CMSD6263S



SOT-323 CASE - MECHANICAL OUTLINE

DIMENSIONS					
	INCHES		MILLIM	ETERS	
SYMBOL	MIN	MAX	MIN	MAX	
А	0.002	0.008	0.05	0.20	
В	0.004	-	0.10	-	
С	-	0.004	-	0.10	
D	0.031	0.043	0.80	1.10	
E	0.071	0.087	1.80	2.20	
F	0.051		1.	30	
G	0.026		0.	65	
Н	0.045	0.053	1.15	1.35	
J	0.079	0.087	2.00	2.20	
K	0.008	0.016	0.20	0.40	
COT 202 (DEV/- D2)					

SOT-323 (REV: R3)



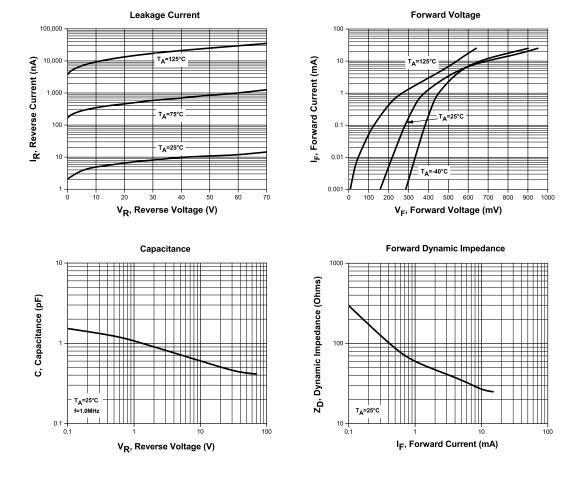
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CMPD6263 CMPD6263A CMPD6263C CMPD6263S

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TYPICAL ELECTRICAL CHARACTERISTICS

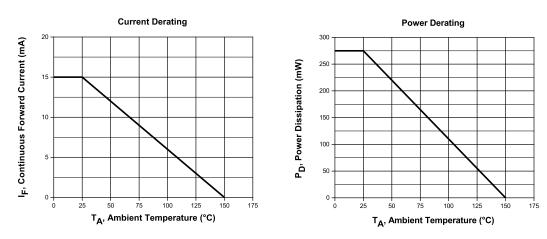
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TYPICAL ELECTRICAL CHARACTERISTICS

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- · Environmental regulation compliance
- Customer specific screening
- · Up-screening capabilities

· Custom product packing

Custom bar coding for shipments

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when 1. ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

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